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FDB024N06 N 沟道 PowerTrench[®] MOSFET 60 V, 265 A, 2.4 mΩ

特性

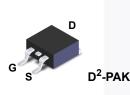
- $R_{DS(on)}$ = 1.8 m Ω (Typ.)@V_{GS} = 10 V, I_D = 75 A
- 快速开关速度
- 低栅极电荷
- 高性能沟道技术可实现极低的 R_{DS(on)}
- 高功率和高电流处理能力
- ・ 符合 RoHS 标准

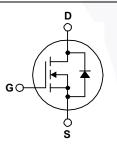
说明

此 N 沟道 MOSFET 采用飞兆半导体先进的 PowerTrench[®] 工艺 生产,这一先进工艺是专为最大限度地降低导通电阻并保持卓越 开关性能而定制的。

应用

- 用于 ATX/ 服务器 / 电信 PSU 的同步整流
- 电池保护电路
- 电机驱动和不间断电源
- 可再生系统





MOSFET 最大额定值 Tc=25°C 除非另有说明。

符号			FDB024N06	单位	
V _{DSS}	漏极一源极电压			60	V
V _{GSS}	栅极一源极电压			±20	V
	-	连续 (T _C = 25°C,硅限制)	2	265	
I _D 漏极电	漏极电流 -	- 连续(T _C = 100°C,硅限制)		190	Α
	-	连续 (T _C = 25°C, 封装限制)		120	
I _{DM}	漏极电流 -	脉冲 (注 1)	1060	Α
E _{AS}	单脉冲雪崩能量	(注2)	2531	mJ
dv/dt	峰值二极管恢复 dv/dt	(注 3)	6.0	V/ns
P _D 功非		T _C = 25°C)		395	W
	切耗 -	降低至 25°C 以上		2.6	W/°C
T _J , T _{STG}	工作和存储温度范围			-55 ? +175	°C
TL	用于焊接的最大引线温度,距离外壳 1/8",持续 5 秒			300	°C

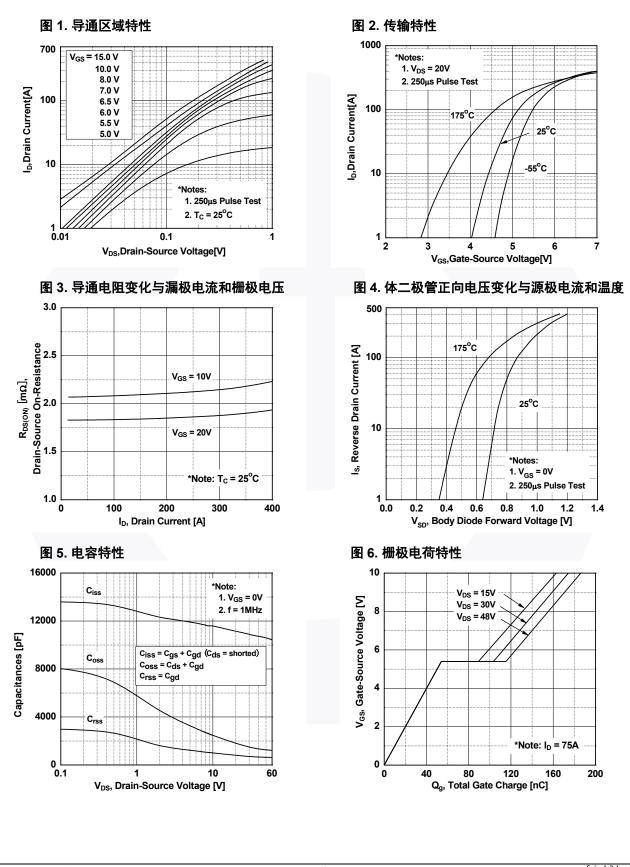
热性能

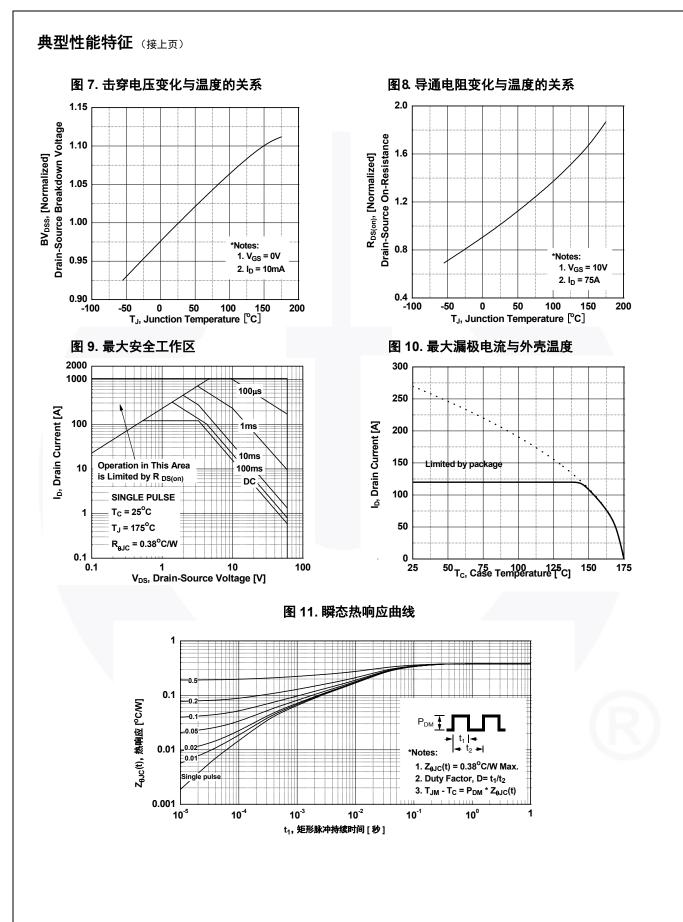
符号	参数	FDB024N06	单位
$R_{\theta JC}$	结至外壳热阻最大值。	0.38	
D	结至环境热阻 (最小尺寸的 2 盎司焊盘)最大值。	62.5	°C/W
$R_{ extsf{ heta}JA}$	结至环境热阻 (1 in ² 2 盎司焊盘)最大值。	40	

2014年1月

器件编号 FDB024N06		顶标 封 筆 FDB024N06 D ² -P		包装方法 卷带	卷尺寸 330 mm		带宽 4 mm		
电气特性	T _C = 25°C) 除非另有说明。							
符号				测试条件	‡	最小值	典型值	最大值	单位
关断特性		~~~~		(A) #4351	•				
	22-11 22	5선수 승수 대				60			V
BV _{DSS} ∆BV _{DSS}	漏 极一游	原极击穿电压		I _D = 250 μA, V _{GS} = 0 V		60	-	-	
ΔDV _{DSS} / ΔTJ	击穿电压	温度系数		I _D = 250 μA,参考 25	5°C	-	0.04	-	V/°C
		正 泪却去法		V _{DS} = 60 V, V _{GS} = 0 V		-	-	1	
DSS	零栅极电	且压漏极电流		$V_{DS} = 60 \text{ V}, V_{GS} = 0$	V, T _C = 150°C	-	-	500	μA
I _{GSS}	栅极 - 体	漏电流		V_{GS} = ±20 V, V_{DS} = () V	-	-	±100	nA
导通特性									
V _{GS(th)}	栅极阈值	自用压		V _{GS} = V _{DS} , I _D = 250	μA	2.5	3.5	4.5	V
R _{DS(on)}		原极静态导通电阻		$V_{GS} = 10 \text{ V}, I_D = 75 \text{ A}$		-	1.8	2.4	mΩ
9 _{FS}	正向跨导			$V_{DS} = 10 \text{ V}, \text{ I}_{D} = 75 \text{ A}$		-	200		S
动态特性									
C _{iss}	输入电容				-	11190	14885	pF	
C _{oss}	输出电容			$V_{DS} = 25 \text{ V}, \text{ V}_{GS} = 0 \text{ V},$ f = 1 MHz		_	1610	2140	pF
C _{rss}	反向传输					-	750	1125	pF
Q _{g(tot)}		册极电荷总量		V _{DS} = 48 V, I _D = 75 A, V _{GS} = 10 V		-	174	226	nC
Q _{gs}						-	54	-	nC
Q _{gd}				(说明4)		-	50	-	nC
 开关特性				1		I			
t _{d(on)}	导通延迟	时间				_	134	278	ns
t _r	开通上升			V _{DD} = 30 V, I _D = 75 A	۹,	-	324	658	ns
t _{d(off)}	关断延迟			V _{GS} = 10 V, R _G = 25		-	348	706	ns
t _f	关断下降时间					250	510	ns	
, 漏极 - 源极					(说明 4)				
I _S	x — 1 					-	-	265	Α
I _{SM}	漏极 - 源极二极管最大正向脉冲电流						-	1060	Α
V _{SD}	漏极 - 源极二极管正向电压		2.000	V _{GS} = 0 V, I _{SD} = 75 A		-	-	1.3	V
t _{rr}	反向恢复			V _{GS} = 0 V, I _{SD} = 75 A		-	69	-	ns
Q _{rr}	反向恢复			$dI_F/dt = 100 A/\mu s$		-	152	-	nC

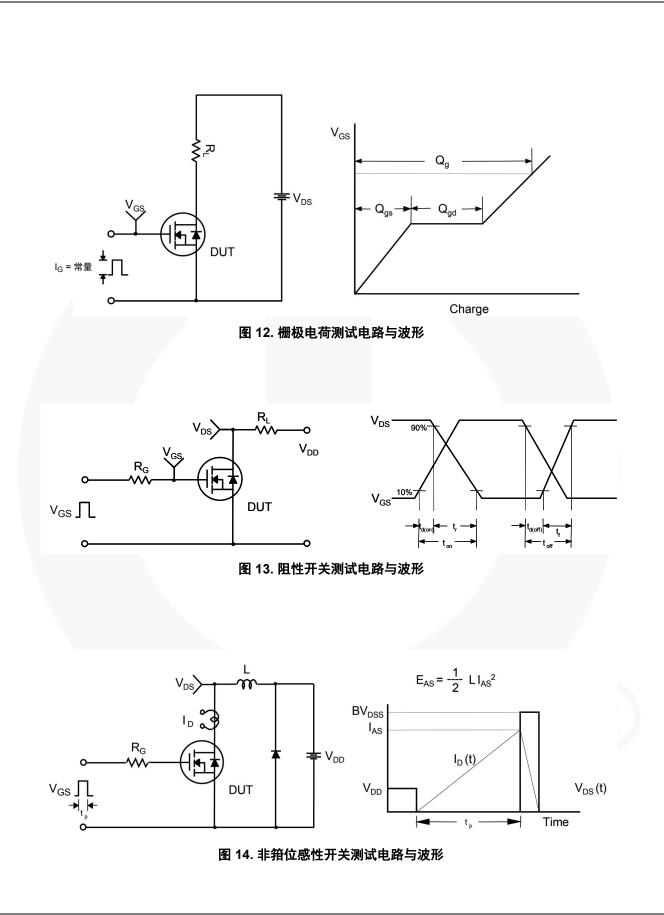
典型性能特征

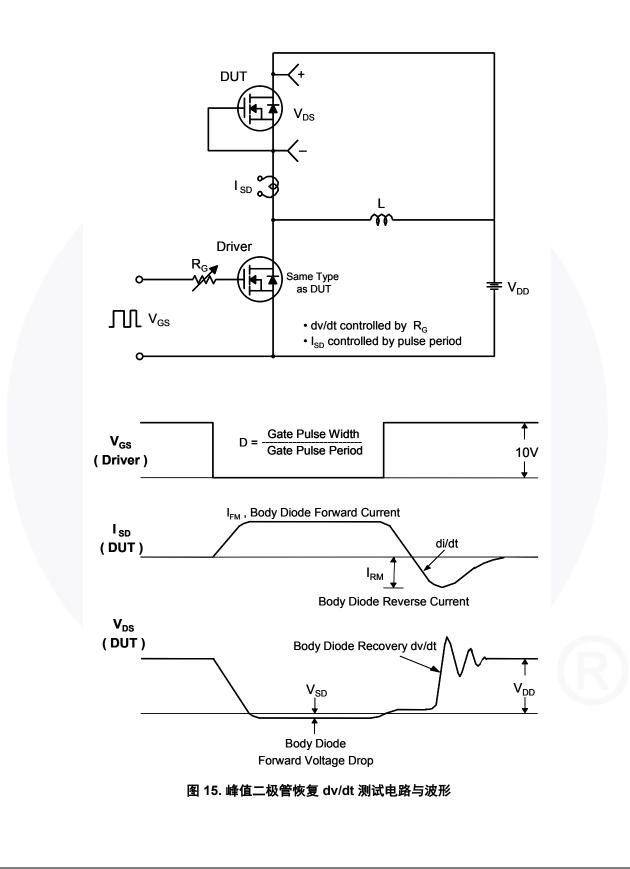


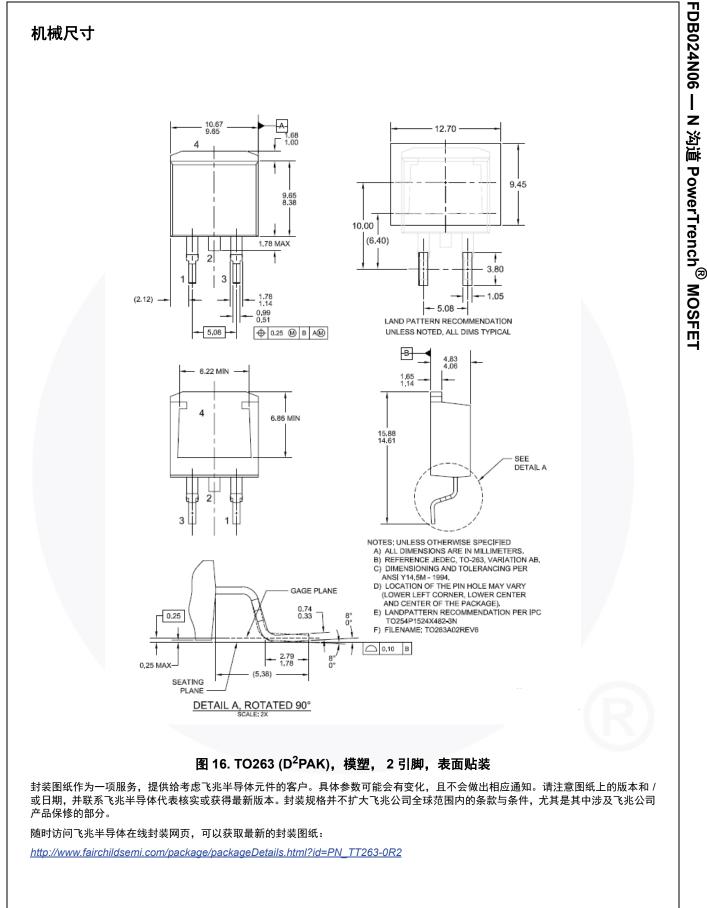


FDB024N06 —

N 沟道 PowerTrench[®] MOSFET







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